

# iStar sCMOS

Fast gated sCMOS solutions

## Ultrafast Platform for Nanosecond Time-resolved Imaging



## **Key Specifications**

- 5.5 megapixel sCMOS
- 50 fps full frame
- High dynamic range at full speed
- Integrated triple output DDG
- Photocathode QE up to 50%
- Integrate-On-Chip gating up to 500 kHz
- USB 3.0 interface

## **Key Applications**

- ✓ Plasma studies
- ✓ Time-resolved Fluorescence / Photoluminescence
- ✓ PLIF imaging / Combustion studies
- √ Hyperspectral Imaging



# iStar sCMOS – Ultrafast acquisition speeds



## Superior **high-speed** acquisition performance

- √ 12-bit high-speed mode
- ✓ 2 times faster than the closest interline-based competitor at an equivalent field-of-view (and over 5 times faster with ROI)

## Market leading acquisition rates...

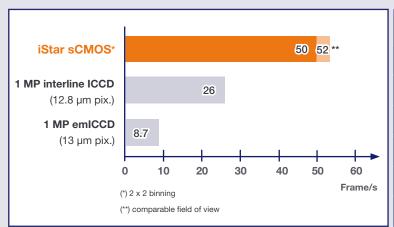


Image Array Size	Frame Rate 12-bit (16-bit)*1
2560 x 2160	50 (50)
2048 x 2048	52 (52)
2160 x 1800 [Ø 18 mm tube fit]	59 (59)
512 x 512	203 (203)
128 x 128	736 (736)
2560 x 8	4,008 (4,008)

### **Delivers:**

- ✓ Faster characterisation of transient plasma, fluorescence or absorption behaviours
- ✓ Faster Echellograme image capture for broadband LIBS-based applications

## PLIF Imaging / Combustion

iStar sCMOS comfortably accommodates the 15 Hz imaging requirement of typical PLIF setups with extremely low noise floor and excellent dynamic range, nanosecond snapshots of the flame and high background light rejection.

Optical inter-frame down to 200 ns for time-gated PIV setups with a wide range of velocities.

## Plasma Imaging

The high frame rate and < 2 ns gating of the iStar sCMOS allow faster reconstruction of plasma dynamics with extremely high temporal resolution.

**GPU Express** for real time data processing.

## **GPU Express**



The Andor GPU Express library has been created to simplify and optimize data transfers from camera to a CUDA-enabled NVidia Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline. GPU Express integrates easily with SDK3 for Windows, providing a user-friendly but powerful solution for management of high bandwidth data flow challenges.

- Enhanced convenience, afforded by simple, optimized GPU data management.
- Optimal data throughout.
- Superb, easily accessible documentation and examples.



## Features & Benefits

Feature	Benefit
50 frames/s acquisition rates	Sustainable rate at full field-of-view, out-performs CCD and interline-based ns gated ICCDs with equivalent field-of-view.
16.6 x 14.0 mm sensor matrix	Large field of view, access more of the useful active area of Ø18 mm image intensifiers without the need for optical tapers.
2.6 e <sup>-</sup> read noise	Highest dynamic range even at the fastest frame rates, up to 5 times better performance than the closest interline-based competitor
12-bit and 16-bit modes	12-bit mode for smaller file size and absolute fastest frame rates, 16-bit for full dynamic range.
Up to 32-bit data transmission to PC	On-head intelligence to preserve dynamic range in extensive pixel binning, or high intensity pixel binning scenarios.
Optical inter-frame down to 300 ns	Ideal for PIV-type applications requiring fast dual images snapshots with high background rejection or supersonic flow analysis.  The true Global Shutter mode facilitates an optical inter-frame gap down to 100 ns, although the intensifier phosphor decay time is the limiting factor. The decay time of a fast P46 phosphor is typically 200 ns (@ 10% intensity).
TE cooling down to 0°C	Efficiently minimizes dark current noise for acquisitions requiring longer sensor exposure time, e.g. integrate-on-chip mode.
High QE Gen 2 & 3 image intensifiers	Superior photon capture, with peak QE up to 50% and spectral coverage from 120 to 1,100 nm.
True optical gating < 2 ns	Billionth of a second time-resolution for accurate transient phenomena study.
Low jitter, on-board Digital Delay Generator (DDG™)	Highest gating timing accuracy with lowest propagation delay. Software controlled 3x triggering outputs with 10 ps setup accuracy for complex experiment integration.
500 kHz sustained photocathode gating (3.3 MHz Burst Mode)	Maximizes signal-to-noise ratio in high repetition rate pulse laser-based applications.  Burst mode allows gate pulse separation down to 300 ns for time-resolved PIV mode.
Photocathode EBI minimization	Dry gas purge interface for further efficient EBI reduction.
Intelligate™	Intelligent and accurate MCP gating for better than 1:108 shuttering efficiency in the UV (Gen 2 image intensifier).
USB 3.0 interface	Super-fast data transfer at 40 fps full frame with a plug-and-play, user-friendly interface – optical extenders available for operation up to 100 m.
GPU Express	Simplify and optimize data transfers from camera to Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline.
Integrated in EPICS	Ease of operation in EPICS software-based facilities such as partner particle accelerators and other large scientific experiments.
2 year warranty	Reliability and guaranteed performance over time.



## Technical Specifications<sup>2</sup>

Sensor type	Front-Illuminated Scientific CMOS		
	2560 x 2160 pixels (W x H), 6.5 μm pixel size		
Sensor matrix	Ø18 mm intensifier  SCMOS Sensor	Ø25 mm intensifier SCMOS Sensor	
	1:1 coupler	1:1 coupler	
Sensor size	16.6 x 14.0 mi 21.8 mm diago		
Pixel well depth (e <sup>-</sup> )	30,000		
Read noise (e <sup>-</sup> ) median [rms] at available pixel readout rates <sup>-3</sup>	@ 200 MHz 2.4 [ @ 560 MHz 2.6 [	•	
Minimum cooling temperature* <sup>4</sup> [dark current, e <sup>-</sup> /pixel/s] air cooled liquid cooled	Ø18 mm photocathode  0°C [0.18]  0°C [0.18]	Ø25 mm photocathode  0°C [0.18]  0°C [0.18]	
Sensor linearity (% maximum)*5	Better than 99.8	3%	
Data range	12-bit (fastest speed) and 16-bit (maximum dynamic range)		
Pixel binning	On-head, pre-defined options 2x2, 4x4 or flexible configuration setup		
Region of Interest	Minimum channel height of 8 rows		
Interface option	USB 3.0		
Internal memory	1 GB		

## Camera and Internal Digital Delay Generator (DDG) Inputs/Outputs

Gate pulse delay & width	Adjustable from 0 ns to 10 s in 10 ps steps			
Trigger Outputs				
Output A, B and C	+5V CMOS level with 50 $\Omega$ source impedance; can drive 5V into a non-terminating load or 2.5V into 50 $\Omega$ load; output synchronized triggers for auxiliary equipment, e.g. lasers, flash lamps, National Instrument hardware Individual delays control from 0 ns to 10 s in 10 ps steps Configurable Polarity			
Fire	5V CMOS level reference signal for beginning and end of individual sensor exposure			
Arm monitor	5V CMOS level reference signal to indicate when system is ready to accept external triggers. Signal goes high when system is ready to accept external triggers (after a readout has finished or sooner if in overlap mode) and goes low when the exposure is finished			
Gate & output A, B and C jitter	35 ps rms (relative to external trigger or to each other)			
	Trigger Inputs			
External trigger	Trigger input for sensor and Digital Delay Generator Up to 500 kHz for Integrate-On-Chip mode			
Direct gate	TTL input for exact external control of photocathode width and timing with smallest insertion delay			
	Additional Controls			
Gate monitoring	AC coupling from photocathode to monitor exact photocathode on/off switching and timings			
Insertion delay	< 19 ns in direct gate operation			

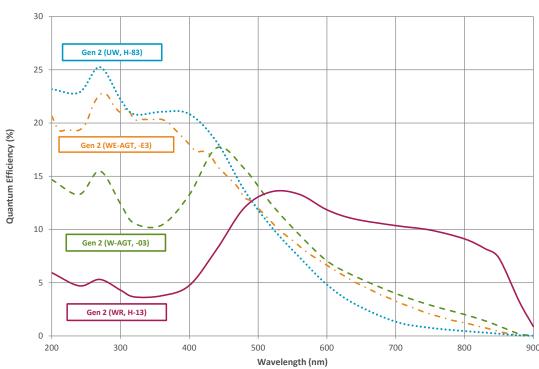


## Specifications: Gen 2 image intensifiers<sup>2</sup>

Photocathode model	18*-03	18*-04	18*-05 <sup>†</sup>	18H-13	18H-83	18*-E3 <sup>*6</sup>
Useful aperture	Ø18 mm (Ø25 mm options also available)					
Input window	Quartz	Quartz	$MgF_2$	Quartz	Quartz	Quartz
Photocathode type	W-AGT	W-AGT	W-AGT	WR	UW	WE-AGT
Minimum guaranteed peak QE @ room temperature *7	18	18	15	13.5	25	22
Wavelength range	180 - 850 nm	180 - 850 nm	120 - 850 nm	180 - 920 nm	180 - 850 nm	180 - 850 nm
Image intensifier resolution limit *8	25 μm	30 μm	25 μm	25 μm	25 μm	25 μm
Phosphor type [decay time to 10%]	P43 [2 ms]	P46 [200 ns]	P43 [2 ms]	P43 [2 ms]	P43 [2 ms]	P43 [2 ms]
Minimum optical gate width (ns) *9, 10						
U (Ultrafast) F (Fast) H (High QE)	< 2 < 5 -	< 2 < 5 -	< 5 < 10	- - < 50	- - < 100	< 2 < 5 -
Maximum relative gain *11	> 1000	> 500	> 1000	> 850	> 500	> 300
Maximum photocathode repetition rate (with Intelligate™ OFF)	500 kHz (continuous)					
Maximum photocathode repetition rate (with Intelligate™ ON)	5 kHz (continuous)					
Equivalent Background Illuminance (EBI)	< 0.2 photoe <sup>-</sup> /pix/sec < 0.4 photoe <sup>-</sup> /pix/sec			< 0.2 photo	oe <sup>-</sup> /pix/sec	

All photocathode types can be combined with a fast-decay P46 phosphor – please contact your local Andor representative for further information

## Quantum Efficiency Curves for Gen 2 Image Intensifiers<sup>17</sup>



<sup>\*</sup> Substitute with appropriate gate width option, e.g. 18F-03 (please refer to page 8 for detailed ordering information)

<sup>†</sup> Available with VUV-compatible spectrograph interface

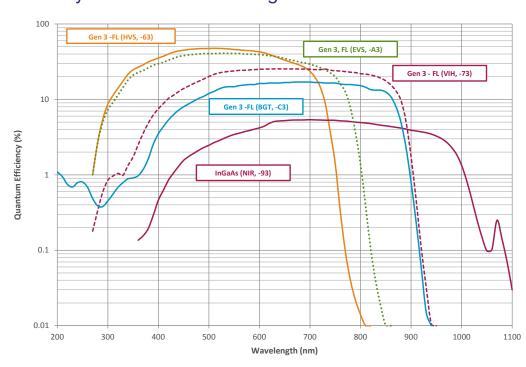


## Specifications: Gen 3 image intensifiers<sup>2</sup>

Photocathode model	18*-63	18*-73	18*-93	18*-A3	18*-C3 *12
Useful aperture	Ø 18 mm (Ø25 mm options also available)				
Input window	Glass	Glass	Glass	Glass	MgF <sub>2</sub> + F/O + Lumogen
Photocathode type	HVS	VIH	NIR	EVS	BGT
Peak QE @ room temperature *7	> 47.5	> 25.5	> 5	> 40	> 17
Wavelength range	280 - 760 nm	280 - 910 nm	380 - 1090 nm	280 - 810 nm	< 200 - 910 nm
Image intensifier resolution limit *8	30 μm	30 µm	30 µm	30 μm	40 μm
Phosphor type [decay time to 10%]	P43 [2 ms]				
Minimum optical gate width (ns) *10					
U (Ultrafast) F (Fast)	< 2 < 5	< 2 < 5	< 3 < 5	< 2 < 5	< 3 < 5
Maximum relative gain *11	> 200				
Maximum photocathode repetition rate (with Intelligate™ OFF)	500 kHz (continuous)				
Maximum photocathode repetition rate (with Intelligate™ ON)			5 kHz (continuous)		
Equivalent Background Illuminance (EBI)	< 0.1 photoe /pix/ sec	< 0.3 photoe /pix/ sec	< 2 photoe /pix/ sec	< 0.2 photoe /pix/ sec	< 0.3 photoe /pix/ sec

All photocathode types can be combined with a fast-decay P46 phosphor – please contact your local Andor representative for further information \* Substitute with appropriate gate width option, e.g. 18U-63 (please refer to page 8 for detailed ordering information)

## Quantum Efficiency Curves for Gen 3 Image Intensifiers 17, 12



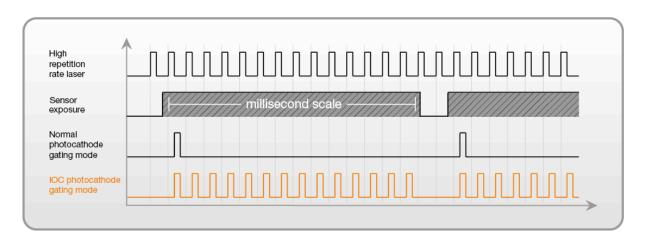


## Intelligent gating modes

### Integrate-On-Chip: 500,000 times more signal per 1 sec sensor exposure

The iStar's Integrate-On-Chip (IOC) mode enables accumulation of useful signal from laser-induced phenomena at frequencies up to 500 kHz, providing greatly improved signal-to-noise, and minimising experiment time. The latter greatly benefits setups where photobleaching-sensitive biological samples are probed. This translates into the possibility to accumulate 500,000 times more signal per 1 second sensor exposure time.

Integrate-On-Chip is fully software-configurable and can be used through extensive kinetic series involving up to 1,000 pre-programmed incremental delays from laser trigger for unrivalled combination of sensitivity and ultra-precise transient phenomena analysis.

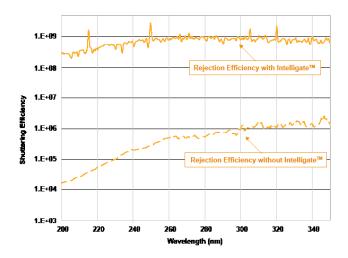


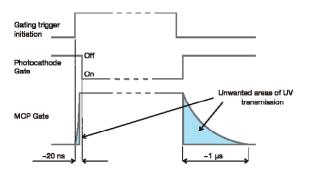
## Intelligate™: Superior gating in the UV-VUV region

One of the key functions of an image intensifier is to provide high optical shuttering (ON/OFF) ratio. By switching photocathode voltage to a higher or lower level relative to the MCP voltage, photo-electrons can be either directed towards or repelled from the MCP to avoid detection. ON/OFF values of 1:10<sup>8</sup> are typically measured for Visible/NIR incident light on the photocathode.

However photocathode "leakage" becomes more pronounced in the UV-VUV region (< 300 nm), where more energetic photons have a greater probability to go through the photocathode turned "OFF", reach the MCP to generate an electron that can be detected. This can lead to shuttering efficiency as low as 1:10<sup>4</sup>.

Andor's exclusive Intelligate™ simultaneously gates the photocathode and the MCP. The ultra fast rising edge of the MCP gate pulse switches on the correct potential in a nanosecond timeframe, coinciding precisely with the photocathode gating pulse. This enables ON/OFF ratios as high as 10<sup>8</sup> in the UV-VUV region.







## Creating the optimum product for you



### Step 1. Choose the intensifier diameter

Intensifier Diameter

Intensifier diameter	Code
Ø 18 mm	18
Ø 25 mm	25

### Step 2. Choose a minimum gating speed



Code
Н
F
U

### Step 3. Select an image intensifier option



Intensifier

Gen 2 Intensifier option	Code
W-AGT photocathode, P43 phosphor	03
W-AGT photocathode, P46 phosphor	04
W-AGT photocathode, MgF <sub>2</sub> window, P43 phosphor	05
WR photocathode, P43 phosphor	13
UW photocathode, P43 phosphor	83
WE-AGT photocathode, P43 phosphor	E3

Gen 3 Intensifier option	Code
HVS photocathode, P43 phosphor	63
VIH photocathode, P43 phosphor	73
NIR photocathode, P43 phosphor	93
EVS photocathode, P43 phosphor	A3
BGT photocathode, P43 phosphor	C3

All photocathode types can be combined with a fast-decay P46 phosphor – please contact your local Andor representative for further information

### Step 4. Select the required accessories and adapters



Adapters

Description	Order Code
C-mount lens adaptor	LM-C
F-mount lens adaptor	LM-NIKON-F
Oasis 160 Ultra compact chiller unit	ACC-XW-CHIL-160
UV-VIS 105mm SLR lens, 250 - 650 nm transmission, F-mount	OL-AF10-F45-#UV
6 mm tubing option for ACC-XW-CHIL-160	ACC-6MM-TUBING-2xxxxM
i <sup>2</sup> c to BNC cable for Shamrock shutter control	ELC-05323
Metric Bracket	ACC-ISTAR-METRIC ADP
15 m active USB 3.0 connector cable (power supply not required)	ACC-ASE-06887
50 m fibre optic USB 3.0 extender solution including power supply	ACC-ASE-08762
100 m fibre optic USB 3.0 extender solution including power supply	ACC-ASE-07860

### Step 5. Select the required software



Software

The iStar sCMOS requires at least one of the following software options:

**Solis for Time-Resolved** A 32-bit and fully 64-bit enabled application for Windows (7, 8 and 10) offering rich functionality for data acquisition and processing. AndorBasic provides macro language control of data acquisition, processing, display and export.

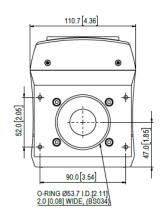
Andor SDK3 A software development kit that allows you to control the Andor sCMOS cameras from your own application. Available as 32 and 64-bit libraries for Windows (7, 8 and 10) and Linux. Compatible with C/C++, LabView and Matlab.

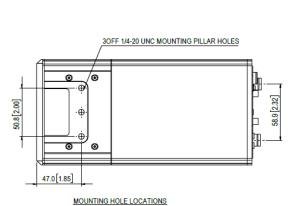
**GPU Express** Andor GPU Express library has been created to simplify and optimize data transfers from camera to a CUDA-enabled NVidia Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline. Integrates easily with Andor SDK3 for Windows.



## Product drawings

Dimensions in mm [inches]





Weight: 4.5 kg [9 lb 15 oz]

#### **REGULATORY COMPLIANCE**

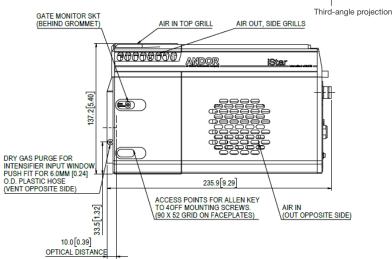
- RoHS compliant
- EU EMC Directive
- EU LV Directive
- IEC 61010-1 CB Scheme

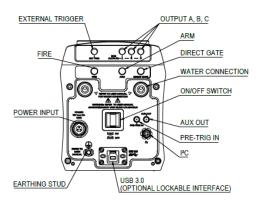
### **EXTERNAL POWER SUPPLY COMPLIANCE**

- UL-certified for Canada and USA
- Japanese PSE Mark

#### **POWER SUPPLY REQUIREMENTS**

- Power: +12 VDC ± 5% @ 5A typ. / 9A max.
- Ripple: 120 mV peak-peak 0 20 MHz
- 100 240 VAC, 43 67 Hz External power supply
- Power Consumption:
  - Camera + External Power Supply (Typ./ Max.): 69 W/ 124 W
  - Camera Only (Typ./ Max.): 60 W/ 108 W





REAR CONNECTOR PANEL

## Connecting to the iStar sCMOS

### **Camera Control**

Connector type: USB 3.0\*13

#### **Logic Input / Output**

Connector type: SMA, provided with SMA - BNC cable 6x outputs: FIRE pulse, Output A, B, C from DDG, ARM, and Aux Out. 3x inputs: Camera trigger from 3rd party source (External Trigger), direct gate for direct external control of intensifier gating, and Pre-Trigger

#### I<sup>2</sup>C connector

Compatible with Fischer SC102A054-130, pin-outs as follow: 1 = Shutter (5V CMOS level with 50  $\Omega$  impedance), 2 = I<sup>2</sup>C Clock (5V), 3 = I<sup>2</sup>C Data (5V), 4 = +5 Vdc, 5 = Ground

#### **Gate Monitor**

1x output: AC coupling to photocathode

#### Aux Out (external mechanical shutter output)

Configured by default to a 5V CMOS level with 50  $\Omega$  impedance shutter output for controlling Andor Shamrock spectrograph mechanical shutters

#### Pre-trigger

Controls the sensor exposure in 'external exposure mode'. Also available in 'external trigger mode' as a optional exclusive trigger to the sensor.





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#### ITEMS SHIPPED WITH YOUR CAMERA

1 x USB 3.0 PCle Card and 1 x 3 m USB 3.0 cable (Type A to B)

1x Gate Monitor cable

2x 2 m BNC to SMA cable

1x Power supply with mains cable

1x Quick Start Guide

1x CD containing Andor user guides

## FOOtnotes: Specifications are subject to change without notice

- Note that the write speed of the PC hard drive can impose a further restriction to achieving sustained kinetic series acquisition.
- 2. Figures are typical unless otherwise stated.
- Readout noise is for the entire system and is taken as a median over the sensor area excluding any regions of blemishes. It is a combination of sensor readout noise and A/D noise.
- 4. Dark current measurement is taken as a median over the sensor area excluding any regions of blemishes.
- 5. Linearity is measured from a plot of Signal vs. Exposure Time over the full dynamic range.
- 6. The On/Off ratio for the 'E3' image intensifier in the UV with MCP gating is typically 10<sup>5</sup>.
- Typical photocathode Quantum Efficiency and input window transmission as measured by the tube manufacturer.
- 8. Typical resolution of the image intensifier tube only, not the overall resolution of the system. As a rough guide, the smallest resolvable FWHM feature will be approximately 4x the sensor pixel size. This is a very important consideration for optical resolution calculations in spectrograph-based systems.
- Gen 2 High QE (H) option Photocathode QE is inherently linked to the gating speed of the intensifier. High
  QE option (H) offers higher peak QE than Ultrafast (U) or Fast (F) intensifiers, while exhibiting minimum gating
  speed one order of magnitude slower.
- 10. Actual measured minimum optical gating of the photocathode, reflecting not only the electrical pulse width applied to the photocathode but also its inherent irising time.
- 11. Gain is software-selectable through a 12-bit DAC and varies exponentially with DAC setting. Value refers to the ratio of max to min intensifier gain as measured for individual cameras. Actual optical gain (counts/photoe) for a DAC setting is accessed by the multiplication of the relative gain (at that DAC value) by the minimum system gain (at DAC = 0, sCMOS e<sup>-</sup>/photoe) and divided by the sCMOS sensitivity (sCMOS e-/count). Sensitivities are individually measured and reported for each system.
- 12. Combination of -73 GaAsP photocathode with a lumogen-coated fibre-optic plate and protective MgF2 window. The latter additional optical interfaces are the reason for the lowered QE in the visible NIR region, for the -C3 model. Note that spectral resolution will be degraded < 450 nm.</p>
- 13. USB 3.0 connection should work with any modern USB 3.0 enabled PC/laptop (provided hard drives or RAM is sufficient to support data rates) as every USB 3.0 port should have its own host controller. iStar sCMOS also ship with a USB 3.0 PCle card as a means to add a USB 3.0 port to an older PC, or as a diagnostic aid to interoperability issues or to ensure maximum speed.

## INSTRUMENTS The Business of Science\*

#### MINIMUM COMPUTER REQUIREMENTS:

- 3 GHz Quad Core
- 4GB RAM (increase RAM if to be used for continuous data spooling)
- Hard Drive: Minimum 450 MB/s continuous write
- PCI Express x4 or greater
- Windows (7, or 8 10) or Linux
- \* See technical note entitled: 'PC Specifications for sCMOS'

#### **Operating and Storage Conditions**

- Operating Temperature:
   0°C to 40°C ambient
- Relative Humidity: < 70% (non-condensing)
- Storage Temperature: -20°C to 55°C

#### **Power Requirements**

• Please refer to page 9





















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